

Serial No. 10/724,803

December 2, 2005

Reply to the Notice of Allowance dated November 8, 2005

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AMENDMENTS TO THE SPECIFICATION:

Please REPLACE the Brief Description of the Drawings on pages 13 and 14 of the Specification with the following amended Brief Description of the Drawings:

Fig. 1 illustrates a first transfer apparatus for use in a preferred embodiment of the present invention;

Fig. 2 illustrates a second transfer apparatus for use in a preferred embodiment of the present invention;

Fig. 3 illustrates a third transfer apparatus for use in a preferred embodiment of the present invention;

Fig. 4 illustrates a fourth transfer apparatus for use in a preferred embodiment of the present invention;

Fig. 5 illustrates a fifth transfer apparatus for use in a preferred embodiment of the present invention;

Figs. 6A and 6B are side-views of an intaglio plate used in a preferred embodiment of the present invention;

Figs. 7A and 7B are flow diagrams for producing a laminate according to a preferred embodiment of the present invention;

Fig. 8 is a light-wavelength versus absorption spectrum of a PET film;

Fig. 9 is a graph illustrating the relationship between the integrated quantity of UV rays of the PET film and the tensile strength thereof;

Fig. 10 is a graph illustrating the relationship between the integrated quantity of UV rays to the shear peeling strength between the electroconductive paste and the intaglio plate; and

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Figs. 11A and 11B are cross-sectional views of a conventional method of forming a thick-film wiring.